DATA SHEET
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## RF Amplifiers, N-Channel MMBF4416



ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :---: | :---: | :---: |
| MMBF4416 | SOT-23 <br> (Pb-Free/ <br> Halide Free) | $3000 /$ <br> Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

1. Device mounted on FR-4 PCB $1.6^{\prime \prime} \times 1.6^{\prime \prime} \times 0.06^{\prime \prime}$.

ELECTRICAL CHARACTERISTICS $\left(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted.)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

## OFF CHARACTERISTICS

| $\mathrm{V}_{\text {(BR) }}$ GSS | Gate-Source Breakdown Voltage | $\mathrm{V}_{\mathrm{DS}}=0, \mathrm{I}_{\mathrm{G}}=1 \mu \mathrm{~A}$ | -30 | - | - | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $I_{\text {GSS }}$ | Gate Reverse Current | $\begin{aligned} & \mathrm{V}_{\mathrm{GS}}=-20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \\ & \mathrm{~V}_{\mathrm{GS}}=-20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0, \mathrm{~T}_{\mathrm{A}}=150^{\circ} \mathrm{C} \end{aligned}$ | - | - | $\begin{gathered} \hline-1 \\ -200 \end{gathered}$ | $\begin{aligned} & \mathrm{nA} \\ & \mathrm{nA} \end{aligned}$ |
| $\mathrm{V}_{\mathrm{GS}}$ (off) | Gate Source Cut-off Voltage | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1 \mathrm{nA}$ | -2.5 | - | -6 | V |
| $V_{G S}$ | Gate Source Voltage | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=0.5 \mathrm{~mA}$ | -1 | - | -5.5 | V |

ON CHARACTERISTICS

| $\mathrm{I}_{\mathrm{DSS}}$ | Zero-Gate Voltage Drain Current | $\mathrm{V}_{\mathrm{GS}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0$ | 5 | - | 15 | mA |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{~V}_{\mathrm{GS}}(\mathrm{f})$ | Gate-Source Forward Voltage | $\mathrm{V}_{\mathrm{DS}}=0, \mathrm{I}_{\mathrm{G}}=1 \mathrm{~mA}$ | - | - | 1 | V |

SMALL SIGNAL CHARACTERISTICS

| $\mathrm{I}_{\mathrm{fS}} \mathrm{I}$ | Forward Transfer Admittance | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0, \mathrm{f}=1 \mathrm{kHz}$ | 4500 | - | 7500 | $\mu \mathrm{mhos}$ |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{os}} \mathrm{I}$ | Output Admittance | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0, \mathrm{f}=1 \mathrm{kHz}$ | - | - | 50 | $\mu \mathrm{mhos}$ |
| $\mathrm{C}_{\text {iss }}$ | Input Capacitance | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0, \mathrm{f}=1 \mathrm{MHz}$ | - | - | 4 | pF |
| $\mathrm{C}_{\mathrm{rss}}$ | Reverse Transfer Capacitance | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0, \mathrm{f}=1 \mathrm{MHz}$ | - | - | 0.9 | pF |
| $\mathrm{C}_{\text {oss }}$ | Output Capacitance | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0, \mathrm{f}=1 \mathrm{MHz}$ | - | - | 2 | pF |

FUNCTIONAL CHARACTERISTICS

| $N F$ | Noise Figure | $V_{D S}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=5 \mathrm{~mA}, \mathrm{R}_{\mathrm{g}}=100 \Omega, \mathrm{f}=100 \mathrm{MHz}$ | - | - | 2 | dB |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{G}_{\mathrm{ps}}$ | Common Source Power Gain | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=5 \mathrm{~mA}, \mathrm{R}_{\mathrm{g}}=100 \Omega, \mathrm{f}=100 \mathrm{MHz}$ | 18 | - | - | dB |

[^0]

SOT-23 (TO-236)
CASE 318-08
ISSUE AS
DATE 30 JAN 2018

## SCALE 4:1



NOTES:
IMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994
. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

|  | MILLIMETERS |  |  | INCHES |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.89 | 1.00 | 1.11 | 0.035 | 0.039 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.000 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.017 | 0.020 |
| $\mathbf{c}$ | 0.08 | 0.14 | 0.20 | 0.003 | 0.006 | 0.008 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| e | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.080 |
| L | 0.30 | 0.43 | 0.55 | 0.012 | 0.017 | 0.022 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.027 |
| $\mathbf{H E}_{\mathbf{E}}$ | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| T | $0^{\circ}$ | --- | $10^{\circ}$ | $0^{\circ}$ | --- | $10^{\circ}$ |

GENERIC
MARKING DIAGRAM*

RECOMMENDED SOLDERING FOOTPRINT


DIMENSIONS: MILLIMETERS


XXX = Specific Device Code
M = Date Code

- = Pb-Free Package
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " $\quad$ ", may or may not be present.


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[^0]:    Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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